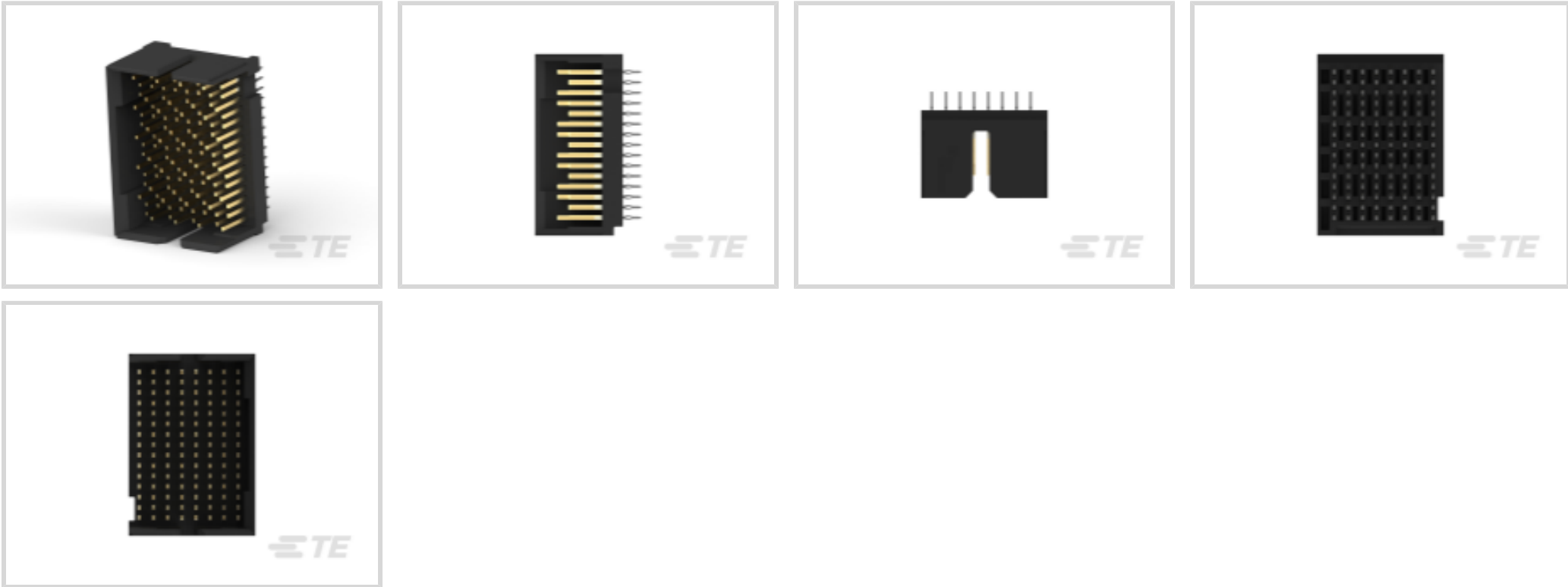




Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



EU RoHS Compliance: **Compliant**

EU ELV Compliance: **Compliant**

Number of Positions: **120**

Row-to-Row Spacing: **2.5 mm [.098 in]**

Mating Alignment: **With**

Features

Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Type Features

Signal Arrangement	Differential
Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Backplane Module Type	Right
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded

Configuration Features

Number of Pairs	40
Number of Signal Positions	80
Backplane Architecture	Traditional Backplane
Stackable	No



Pairs per Column	5
Number of Positions	120
Number of Rows	15
Number of Columns	8
PCB Mount Orientation	Vertical

Electrical Characteristics

Operating Voltage	250 VAC
Impedance	100 Ω

Signal Characteristics

Data Rate	10 Gb/s
Differential Impedance	100 Ω
Number of Differential Pairs per Column	5

Body Features

Primary Product Color	Black
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Contact Features

PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
PCB Contact Termination Area Plating Material Thickness	.5 μm[20 μin]
Contact Shape & Form	Rectangular
Contact Mating Area Plating Material	Gold
Contact Mating Area Length	6 mm[.236 in]
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	.5 A

Termination Features

Termination Method to PCB	Through Hole - Press-Fit
Termination Post & Tail Length	2.5 mm[.098 in]

Mechanical Attachment

Guide Hardware	Without
PCB Mount Retention	With
Mating Retention	Without



PCB Mount Retention Type	Action/Compliant Tail
PCB Mount Alignment	Without
Mating Alignment	With
Mating Alignment Type	Guide Slot
Connector Mounting Type	Board Mount

Housing Features

Number of Shrouded Sides	3
End Wall Location	Right
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]

Dimensions

Connector Width	24.4 mm
Connector Height	11.8 mm
PCB Hole Diameter	.47 mm
Connector Length	15.35 mm
Row-to-Row Spacing	2.5 mm[.098 in]

Usage Conditions

Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

Compatible With Agency/Standards Products	UL
UL Flammability Rating	UL 94V-0
Compatible With Approved Standards Products	UL E28476

Packaging Features

Packaging Method	Tube, Box & Tube
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Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

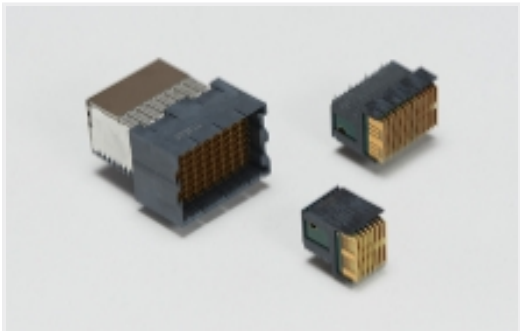
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 1934218-1
Tin Man Recept Assy 5 pair 8 Column

Also in the Series | Z-PACK TinMan



High Speed Backplane Connectors(68)

Customers Also Bought



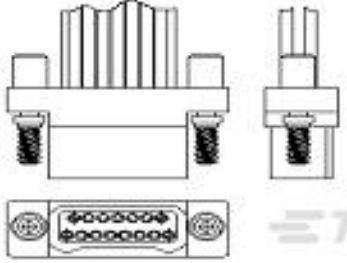
TE Part #1934272-1
Tin Man Header Assy 5x8 left



TE Part #1-5645501-2
SKT MS S4 BN SN-SN 10M W/SEAL



TE Part #462481-000
55PC0221-18-6/9



TE Part #3-1589472-4
STL015PC2DC036N = WDUALOBE



TE Part #2-1617019-0
FW1105G00 = 2020-FW RELAY



TE Part #6469083-2
HMZD 3PAIR, HDR ASSY, 25MM MOD



TE Part #5415406-2
TEST PLUG, RTANG, PCB, G

Documents

Product Drawings

Tin Man Header Assy 5x8 Left

English

CAD Files

Customer View Model

ENG_CVM_1934273-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_1934273-1_B.3d_stp.zip

English

Customer View Model

ENG_CVM_1934273-1_B.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Z-PACK TinMan High Speed High Density Backplane Connector Catalog 5-1773447-9

English

Product Specifications

Application Specification

English

1934273-1

120 Position, Mating Alignment, Guide Slot Mating Alignment Type, 15 Row, 8 Column, PCB Mount Header, Z-PACK TinMan, High Speed Backplane Connectors

